

DATA SHEET

THIN FILM CHIP RESISTORS General purpose

RJ series 1%, TC50 sizes 0402/0603/0805/1206/ 1210/2010/2512 RoHS compliant





YAGEO Phicomp

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<u>SCOPE</u>

This specification describes RJ0402 to RJ2512 general purpose chip resistors with leadfree terminations made by thin film process.

APPLICATIONS

- Converters
- Printer equipment
- Server board
- Telecom
- Consumer

FEATURES

- RoHS compliant
 - Products with lead free terminations meet RoHS requirements
 - Pb-glass contained in electrodes
 - Resistor element and glass are exempted by RoHS
- Reducing environmentally hazardous wastes
- High component and equipment reliability
- Saving of PCB space
- None forbidden-materials used in products/production
- Halogen Free Epoxy

ORDERING INFORMATION - GLOBAL PART NUMBER & 12NC

Both part numbers are identified by the series, size, tolerance, packing type, temperature coefficient, taping reel and resistance value.

YAGEO BRAND ordering code

GLOBAL PART NUMBER (PREFERRED)

RJ XXXX F X E XX XXXX L

(1) (2) (3) (4) (5) (6) (7)

(I) SIZE

0402 / 0603 / 0805 / 1206 / 1210 / 2010 / 2512

(2) TOLERANCE

 $F = \pm 1\%$

(3) PACKAGING TYPE

- R = Paper taping reel
- K = Embossed taping reel

(4) TEMPERATURE COEFFICIENT OF RESISTANCE

 $E = \pm 50 \text{ ppm/°C}$

(5) TAPING REEL

07 = 7 inch dia. Reel 10 = 10 inch dia. Reel 13 = 13 inch dia. Reel

(6) RESISTANCE VALUE

There are $2\sim4$ digits indicated the resistor value. Letter R/K/M is decimal point, no need to mention the last zero after R/K/M, e.g. I K2, not I K20.

Detailed resistance rules show in table of "Resistance rule of global part number".

(7) OPTIONAL CODE

L = optional symbol (Note)

Resistance rule number Resistance code ru	of global part le Example
XRXX (I to 9.76 Ω)	R = Ω R5 = .5 Ω 9R76 = 9.76 Ω
XXRX	IOR = 10 Ω
(10 to 97.6 Ω)	97R6 = 97.6 Ω
XXXR (100 to 976 Ω)	100R = 100 Ω
XKXX	IK = 1,000 Ω
(I to 9.76 KΩ)	9K76 = 9760 Ω
XMXX	IM = 1,000,000 Ω
(I to 9.76 MΩ)	9M76= 9,760,000 Ω

ORDERING EXAMPLE

The ordering code of a RJ0603 chip resistor, TC50 value 56 Ω with ±1% tolerance, supplied in 7-inch tape reel is: RJ0603FRE0756R(L).

NOTE

- I. All our RSMD products meet RoHS compliant. "LFP" of the internal 2D reel label mentions "Lead Free Process"
- 2. On customized label, "LFP" or specific symbol printed and the optional "L" at the end of GLOBAL PART NUMBER / I2NC can be added (both are on customer request)

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PHYCOMP BRAND ordering codes

Both GLOBAL PART NUMBER (preferred) and I2NC (traditional) codes are acceptable to order Phycomp brand products.

GLOBAL PART NUMBER (PREFERRED)

For detailed information of GLOBAL PART NUMBER and ordering example, please refer to page 2.

12NC CODE

2390	390 <u>XXX X</u> XXXX L									
(I)		(2)) (3) (4)							
RJ	RI START TOL. RESISTANCE		RESISTANCE	EMBOSSED TAPE ON REEL ⁽²⁾	EMBOSSED TAPE ON REEL ⁽²⁾ PAPER TAPE ON REEL (uni			cs) ⁽²⁾		
SİZE	IN ⁽¹⁾	(%)	RANGE	4,000	5,000	10,000	20,000	50,000		
0402	2390	±1%	10 Ω to 121 k Ω	-	-	407 8xxxx	427 8xxxx	447 8xxxx		
0603	2390	±1%	5.1 Ω to 681 k Ω	-	404 8xxxx	424 8xxxx	444 8xxxx	-		
0805	2390	±1%	5.1 Ω to 1.5 M Ω	-	401 8xxxx	421 8xxxx	441 8xxxx	-		
1206	2390	±1%	5.1 Ω to 1.5 M Ω	-	411 8xxxx	431 8xxxx	451 8xxxx	-		
1210	2390	±1%	5.1 Ω to 1 M Ω	-	412 0xxxx	432 8xxxx	412 8xxxx	-		
2010	2390	±1%	10 Ω to 1 M Ω	415 8xxxx	-	-	-	-		
2512	2390	±1%	10 Ω to 1 MΩ	418 8xxxx	-	-	-	-		

- (1) The resistors have a 12-digit ordering code starting with 2390.
- (2) The subsequent 4 digits indicate the resistor tolerance and packaging.
- (3) The remaining 4 digits represent the resistance value with the last digit indicating the multiplier as shown in the table of "Last digit of I2NC".
- (4) "L" is optional symbol (Note)

ORDERING EXAMPLE

The ordering code of a RJ0603 resistor, TC50 value 56 Ω , with ±1% tolerance, supplied in tape of 5,000 units per reel is: 239040485609(L) or RJ0603FRE0756R(L).

NOTE

- I. All our RSMD products are RoHS compliant. "LFP" of the internal 2D reel label mentions "Lead Free Process"
- 2. On customized label, "LFP" or specific symbol printed and the optional "L" at the end of GLOBAL PART NUMBER / 12NC can be added (both are on customer request)

Last digit of I2NC

	,					
Resistance	Resistance decade ⁽³⁾					
0.01 to 0.0	976 Ω		0			
0.1 to 0.97	7					
l to 9.76 🤇	8					
10 to 97.6	9					
100 to 976	δΩ		I			
l to 9.76 k	Ω		2			
10 to 97.6	kΩ		3			
100 to 976	kΩ		4			
l to 9.76 N	ſΩ		5			
10 to 97.6	MΩ		6			
Example:	0.02 Ω	=	0200 or 200			
	0.3 Ω	=	3007 or 307			
	ΙΩ	=	1008 or 108			
	33 kΩ	=	3303 or 333			
	10 MΩ	=	1006 or 106			

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	Chip Resisto	Pr Surface Mount RJ SERIES 0402 to 2512 (RoHS Compliant)	-
<u>MARKING</u>			
KJ0805 / KJT	206 / RJ1210 / RJ2	010 / RJ2512	
	007	Either resistance in E-24 or E-96: 4 digits	
Fig. I Val	$ue = 10 k\Omega$	First three digits for significant figure and 4th digit for numbe	er of zeros
RJ0603			
	123	E-24 series: 3 digits	
Fig. 2 Val	ue = $12 k\Omega$	First two digits for significant figure and 3rd digit for number	of zeros
	100	E-96 series: 3 digits for 0603+1% FIA-96 marking method	
Fig. 3 Val	ue = 12.4 kΩ		



For further marking information, please see special data sheet "Chip resistors marking".



Chip Resistor Surface Mount RJ

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CONSTRUCTION

A metal film layer is deposited on a high-grade ceramic body (aluminium oxide). It is given the approximate resistance required and the value is trimmed to within tolerance by laser cutting of this resistive layer.

Internal metal electrodes are formed into several layers at each end as a contact. To guarantee optimum solderability, the outer layer consists of matte tin.

The resistive layer is covered with a protective coat and printed with the resistance value. See fig. 5.

 Table I
 For outlines see fig. 5

TYPE	L (mm)	W (mm)	H (mm)	l⊨(mm)	l₂ (mm)
RJ0402	1.00 ±0.10	0.50 ±0.05	0.30 ±0.05	0.20 ±0.10	0.25 ±0.10
RJ0603	1.60 ±0.10	0.80 ±0.10	0.45 ±0.10	0.25 ±0.15	0.25 ±0.15
RJ0805	2.00 ±0.10	1.25 ±0.10	0.50 ±0.10	0.35 ±0.20	0.35 ±0.20
RJ1206	3.10 ±0.10	1.60 ±0.10	0.55 ±0.10	0.45 ±0.20	0.40 ±0.20
RJ1210	3.10 ±0.10	2.60 ±0.15	0.55 ±0.10	0.50 ±0.20	0.50 ±0.20
RJ2010	5.00 ±0.10	2.50 ±0.15	0.55 ±0.10	0.60 ±0.20	0.50 ±0.20
RJ2512	6.35 ±0.10	3.20 ±0.15	0.55 ±0.10	0.60 ±0.20	0.50 ±0.20

OUTLINES



ELECTRICAL CHARACTERISTICS

Table	2						
TYPE	RESISTANCE RANGE	OPERATING TEMPERATURE RANGE	POWER RATING	MAXIMUM WORKING VOLTAGE	DIELECTRIC WITHSTAND VOLTAGE	MAXIMUM OVERLOAD VOLTAGE	TEMPERATURE COEFFICIENT OF RESISTANCE
RJ0402	10 Ω to 121 KΩ	–55 °C to +125 °C	1/16 W	25 V	100 V	100 V	±50 ppm/°C
RJ0603	5. Ω to 68 KΩ	–55 °C to +125 °C	1/16 W	50 V	100 V	100 V	±50 ppm/°C
RJ0805	5.1 Ω to 1.5 M Ω	–55 °C to +125 °C	1/10 W	100 V	250 V	200 V	±50 ppm/°C
RJ I 206	5.1 Ω to 1.5 M Ω	–55 °C to +125 °C	1/8 W	150 V	250 V	250 V	±50 ppm/°C
RJ1210	5.1 Ω to 1 M Ω	–55 °C to +125 °C	1/4 W	150 V	400 V	300 V	±50 ppm/°C
RJ2010	10 Ω to 1 M Ω	–55 °C to +125 °C	1/2 W	150 V	400 V	300 V	±50 ppm/°C
RJ2512	10 Ω to 1 M Ω	–55 °C to +125 °C	3/4 W	150 V	400 V	300 V	±50 ppm/°C

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FOOTPRINT AND SOLDERING PROFILES

For recommended footprint and soldering profiles, please see the special data sheet "Chip resistors mounting".

PACKING STYLE AND PACKAGING QUANTITY

Table 3 Packing style and packaging quantity

PACKING STYLE	REEL DIMENSION	RJ0402	RJ0603	RJ0805	RJ1206	RJ1210	RJ2010	RJ2512
Paper taping reel (R)	7" (178 mm)	10,000	5,000	5,000	5,000	5,000		
	10" (254 mm)	20,000	10,000	10,000	10,000	10,000		
	13" (330 mm)	50,000	20,000	20,000	20,000	20,000		
Embossed taping reel (K)	7" (178 mm)						4,000	4,000

NOTE

1. For Paper/Embossed tape and reel specification/dimensions, please see the special data sheet "Packing" document.

FUNCTIONAL DESCRIPTION

OPERATINGTEMPERATURE RANGE

Range: -55°C to +125°C

POWER RATING

Each type rated power at 70°C: RJ0402=1/16 W, RJ0603=1/16 W, RJ0805=1/10 W, RJ1206=1/8 W, RJ1210=1/4 W, RJ2010=1/2 W, RJ2512=3/4 W.

RATED VOLTAGE

The DC or AC (rms) continuous working voltage corresponding to the rated power is determined by the following formula:

 $V = \sqrt{P \times R}$

Where

V = Continuous rated DC or AC (rms) working voltage (V)

P = Rated power (W)

 $R = Resistance value (\Omega)$





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TESTS AND REQUIREMENTS

Table 4 Test condition, procedure and requirements

TEST	TEST METHOD	PROCEDURE	REQUIREMENTS
Life/ Operational Life/ Endurance	MIL-STD-202F-method 108A IEC 60115- 4.25.1 JIS C 5202-7.10	1,000 hours at 70°C \pm 5°C applied RCWV 1.5h on, 0.5h off, still air required	±(1%+0.05 Ω)
High Temperature Exposure/ Endurance at upper category temperature	MIL-STD-202F-method 108A IEC 60115- 4.25.3 JIS C 5202-7.11	1,000 hours at maximum operating temperature depending on specification, unpowered No direct impingement of forced air to the parts Tolerances: 125±3 °C	±(0.5%+0.05 Ω)
Moisture Resistance	MIL-STD-202F-method 106F IEC 60115- 4.24.2	Each temperature / humidity cycle is defined at 8 hours (method 106F), 3 cycles / 24 hours for 10d with 25 °C / 65 °C 95% R.H, without steps 7a & 7b, unpowered Parts mounted on test-boards, without condensation on parts Measurement at 24±2 hours after test conclusion	±(0.5%+0.05 Ω)
Thermal Shock	MIL-STD-202 Method 107	-55/+125 °C Note: Number of cycles required is 300. Devices unmounted Maximum transfer time is 20 seconds. Dwell time is 15 minutes. Air – Air	±(0.5%+0.05 Ω)
Short time overload	MIL-R-55342D-para 4.7.5 IEC60155-1 4.6.1.1	2.5 times RCWV or maximum overload voltage whichever is less for 5 sec at room temperature	±(1%+0.05 Ω)
Board Flex/ Bending	IEC60115-1 4.33 IEC60068-2-21 Ue1	Device mounted on PC board as described, only I board bending required Bending: sizes ≤ 1206 : 3mm sizes > 1206 : 2mm Bending time: 60±5 seconds Ohmic value checked during bending	±(1%+0.05 Ω)

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TEST	TEST METHOD	PROCEDURE	REQUIREMENTS
Solderability			
- Wetting	J-STD-002	Electrical Test not required. Magnification 50X.	Well tinned (≥95%
		SMD conditions:	covered)
		I st step: method B, aging 4 hours at 155°C dry heat	No visible damage
		2 nd step: leadfree solder bath at 245±3°C Dipping time: 3±0.5 seconds	
- Leaching	EIA/IS 4.13B	Leadfree solder, 260 °C, 30 seconds immersion time	No visible damage
	IEC 60115-8 4.18		
- Resistance to	MIL-STD-202 Method 210	Condition B, no pre-heat of samples	±(0.5%+0.05 Ω)
Soldering Heat		Leadfree solder, 270 °C, 10 seconds immersion time	
		Procedure 2 for SMD: devices fluxed and cleaned with isopropanol	



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<u>REVISION HISTORY</u>

REVISION	DATE	CHANGE NOTIFICATION	DESCRIPTION
Version 2	Jul II, 2008	-	- Change to dual brand datasheet that describe RJ0402 to RJ2512 with RoHS compliant
			- Modify ordering information - global part number & I2NC
			- Modify electrical characteristic
			- Tests and requirements update
Version I	May 30, 2005	-	- New datasheet for thin film general purpose chip resistors sizes of 0201/0402/0603/0805/1206/1210/2010/2512 1%, TC50 with lead-free terminations

